

**AMENDMENT TO THE SPECIFICATION**

Please replace the paragraph beginning at page 2, line 20, to page 3, line 8, with the following rewritten paragraph:

-- Referring to Figs. 3 and 4, the memory card 20 of the present invention comprises a base plate 21 on which different types of IC chips 23 such as a Passive chip 22, a Flash chip 231, and a Controller chip 232 are connected. Each of the chips has connection legs 230 electrically connected to the base plate 21 so as to form a circuit board. A case 24 is mounted to the base plate 21 and at least one window 241 is defined through the case 24 so that at least one of the IC chips 23 such as the Flash chip 231 in Fig. 4 or the Controller chip 232 as shown in Fig. 5 is accommodated in the window 241 because the space enclosed by the at least one window 241 is slightly larger than the at least one of the IC chips 23. Preferably, a periphery of the at least one of the IC chips 23 is fitted and in contact with an inner periphery of the at least one window 241. The top surface of the chips that are accommodated in the at least one window 241 is in flush with the top surface of the case 24. A seal plate 25 is attached on the case 24 and seals the at least one window 241. It is to be noted that necessary processes such as filling the plastic material are proceeded as does to the conventional memory cards. --